DIGITRON SEMICONDUCTORS

MCR8D, MCR8M, MCR8N

SILICON CONTROLLED RECTIFIERS

Available Non-RoHS (standard) or RoHS compliant (add PBF suffix). Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Peak repetitive off-state voltage ⁽¹⁾	V_{DRM}			
Peak repetitive reverse voltage	V_{RRM}			
$(T_J = -40 \text{ to } +125^{\circ}\text{C})$			V	
MCR8D		400	V	
MCR8M		600		
MCR8N		800		
On-state RMS current (all conduction angles)	$I_{T(RMS)}$	8	А	
Peak non-repetitive surge current			Δ.	
(one half-cycle, 60Hz, $T_J = 125$ °C)	I_{TSM}	80	A	
Circuit fusing (t = 8.3ms)	I ² t	26.5	A ² s	
Peak gate power (pulse width $\leq 1.0 \mu s$, $T_C = 80 \degree C$)	P _{GM}	5	W	
Average gate power (t = 8.3 ms, $T_C = 80$ °C)	$P_{G(AV)}$	0.5	W	
Peak gate current (pulse width ≤ 1.0µs, T _C = 80°C)	${ m I}_{\sf GM}$	2	А	
Operating temperature range	T ₁	-40 to +125	°C	
Storage temperature range	T _{stg}	-40 to +150	°C	

THERMAL CHARACTERISTICS

Characteristic	Symbol	Maximum	Unit
Thermal resistance, junction to case	$R_{ ext{ iny JC}}$	2.0	°C/W
Thermal resistance, junction to ambient	$R_{\scriptscriptstyle \Theta JA}$	62.5	°C/W
Maximum lead temperature for soldering purposes 1/8" from case for 10s	TL	260	°C

Note 1: V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

ELECTRICAL CHARACTERISTICS (T_C = 25°C, unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•			_	
Peak forward blocking current	I_{DRM}				
Peak reverse blocking current	\mathbf{I}_{RRM}				
$(V_{AK} = Rated V_{DRM} or V_{RRM}, gate open)$					mA
$T_1 = 25$ °C		-	-	0.01	
$T_{J} = 125^{\circ}C$		-	-	2.0	
ON CHARACTERISTICS					
Peak on-state voltage *	V		-		V
$(I_{TM} = 16A)$	V _{TM}	-		1.8	
Gate trigger current (continuous dc)					0
$(V_D = 12V, R_L = 100\Omega)$	${ m I}_{ m GT}$	2.0	7.0	15	mA
Gate trigger voltage (continuous dc)	.,				V
$(V_D = 12V, R_L = 100\Omega)$	V_{GT}	0.5	0.65	1.0	V
Holding current (anode voltage = 12V)	I _H	4.0	22	30	mA
DYNAMIC CHARACTERISTICS					
Critical rate of rise of off-state voltage	dv/d+				\//us
$(V_D = rated V_{DRM}, exponential waveform, gate open, T_1 = 125°C)$	dv/dt	50	200	-	V/µs

^{*} Pulse width ≤ 2.0ms, duty cycle ≤ 2%.

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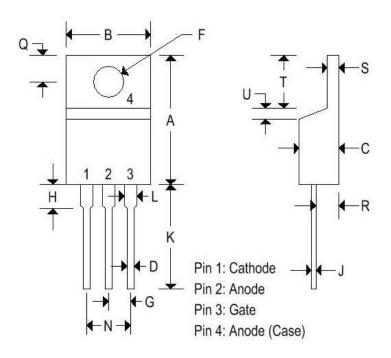
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MECHANICAL CHARACTERISTICS

Case	TO-220AB
Marking	Alpha-numeric
Pin out	See below



	TO-220 A B				
	Inches		Millimeters		
	Min	Max	Min	Max	
Α	0.575	0.620	14.600	15.750	
В	0.380	0.405	9.650	10.290	
С	0.160	0.190	4.060	4.820	
D	0.025	0.035	0.640	0.890	
F	0.142	0.147	3.610	3.730	
G	0.095	0.105	2.410	2.670	
Н	0.110	0.155	2.790	3.930	
J	0.014	0.022	0.360	0.560	
K	0.500	0.562	12.700	14.270	
L	0.045	0.055	1.140	1.390	
N	0.190	0.210	4.830	5.330	
Q	0.100	0.120	2.540	3.040	
R	0.080	0.110	2.040	2.790	
S	0.045	0.055	1.140	1.390	
T	0.235	0.255	5.970	6.480	
U		0.050	18	1.270	
٧	0.045	926	1.140	F2-20	
Z	196	0.080	15	2.030	